

LINEAR IC**8-Bit D/A Converter
with Operational Amplifier Output Buffers****MB88344/88344B****■ DESCRIPTION**

MB88344/MB88344B are 8-bit 36 channels D/A converters which have two reference voltages to use 36 channels as 12 channels and 24 channels independently.

Each output channels has an operational amplifier output buffer and so large current drive is possible.

In the MB88344B, 6 Channels of DAC output (AO_{31} - AO_{36}) have four data registers each and so, the analog output can be changed by the address input from A0 and A1 pins.

Digital data are input to the devices in serial and it is controlled by CLK and LD pins. This configuration makes a cascade connections between devices.

The MB88344/MB88344B are suitable for electronic volumes and replacement for potentiometers for adjustment, in addition to normal D/A converter applications.

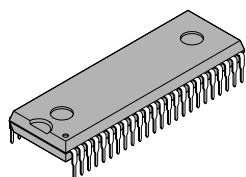
■ FEATURES

- Ultra low power consumption : Type. 1.1mW/channel
- Ultra small package
- Conversion method : R-2R resistor ladder
- On-chip operational amplifier output buffers : Max. +1.0/-1.0mA analog output sink/source current capability
- Analog data output range : 0 to V_{CC} [V]
- Two analog output reference voltage : Analog data can be output in different reference voltages.

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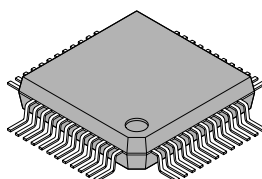
■ PACKAGES

48 pin, Plastic SH-DIP



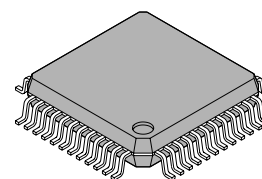
(DIP-48P-M01)

48 pin, Plastic QFP



(FPT-48P-M16)

48 pin, Plastic LQFP



(FPT-48P-M05)

This device contains circuitry to protect the inputs against damage due to high static voltages or electric fields. However, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high impedance circuit.

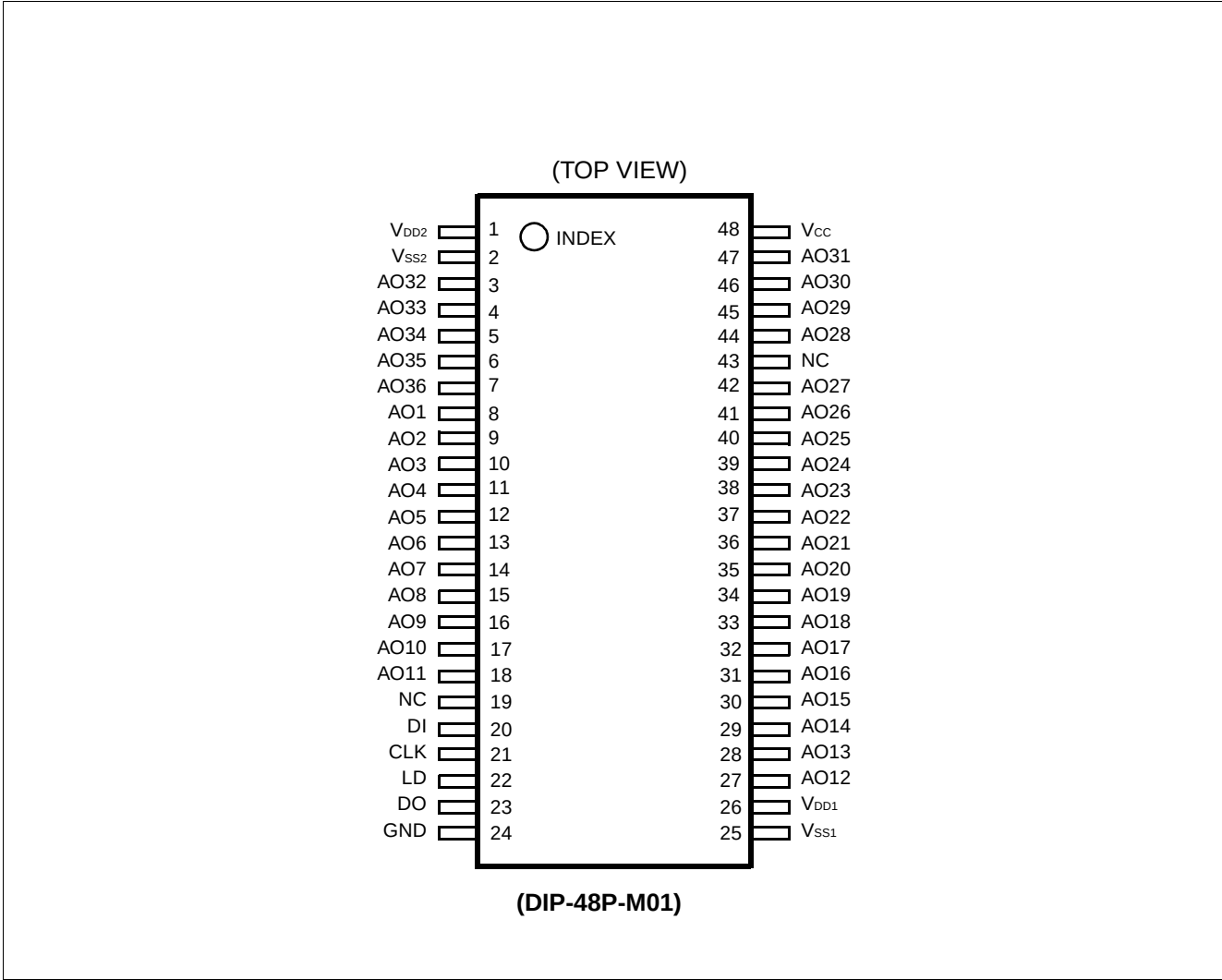
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- For data registers for AO₃₁-AO₃₆ channels (MB88344B only) : Analog output can be changed by the A0 and A1 analog block.
- Separate supply voltage for digital block and analog block.
- Direct control can be done from 3 V-system MCU:
 - MB88344 : Input "H" Voltage = 0.5 V_{CC}, Input "L" Voltage = 0.2 V_{CC}
 - MB88344B : Input "H" Voltage = 2.1 V, Input "L" Voltage = 0.6 V
- Max. 2.5 MHz serial data input
- Silicon-gate CMOS process
- Package options:
 - MB88344: 48-pin plastic SH-DIP/QFP/LQFP
 - MB88344B: 48-pin plastic SH-DIP/LQFP

	MB88344	MB88344B
Number of digital for AO ₃₁ to AO ₃₆	1	4
Shift register	14-bit	16-bit
Shift register format	MSB first	LSB first
Package	SH-DIP-48P/QFP-48P/LQFP-48P	SH-DIP-48P/LQFP-48P

PIN ASSIGNMENTS

MB88344

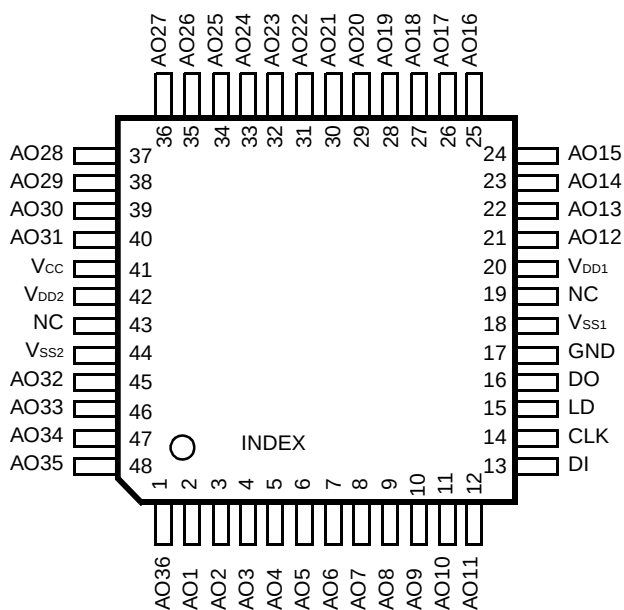


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MB88344/MB88344B

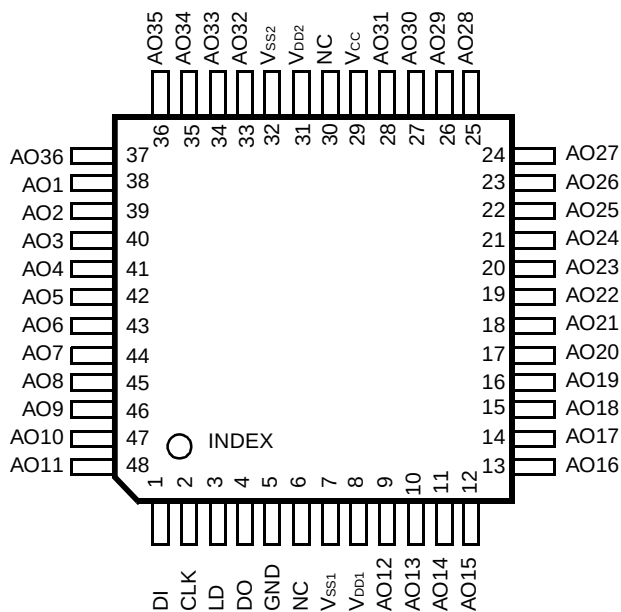
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(TOP VIEW)



(FPT-48P-M16)

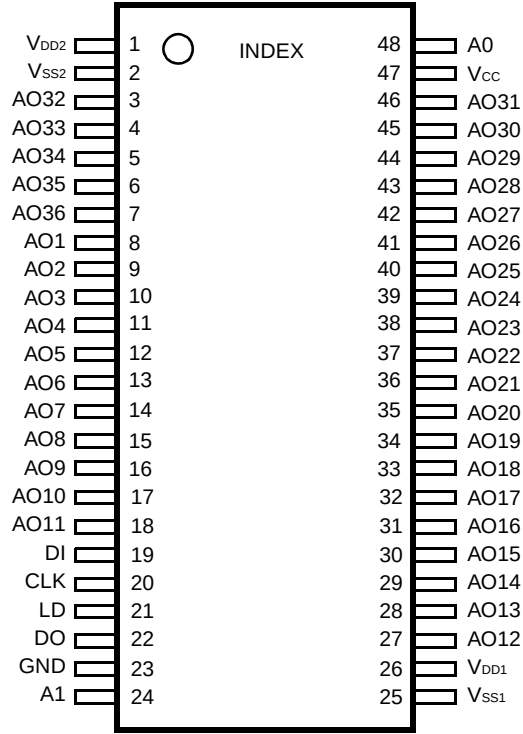
(TOP VIEW)



(FPT-48P-M05)

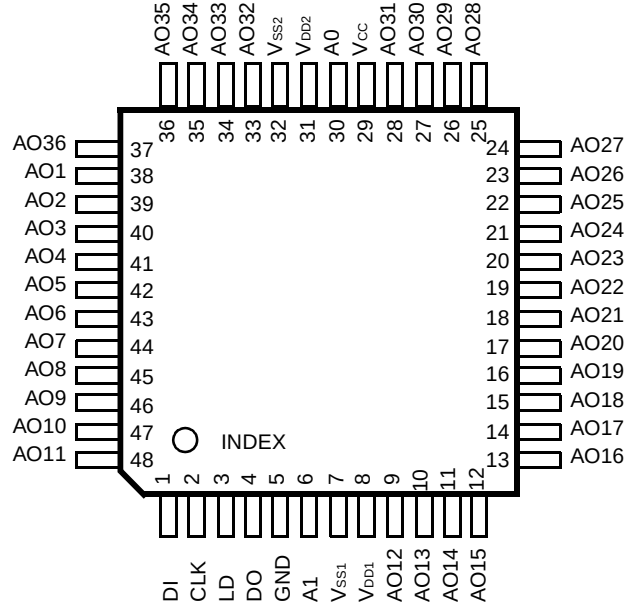
MB88344B

(TOP VIEW)



(DIP-48P-M01)

(TOP VIEW)



(FPT-48P-M05)

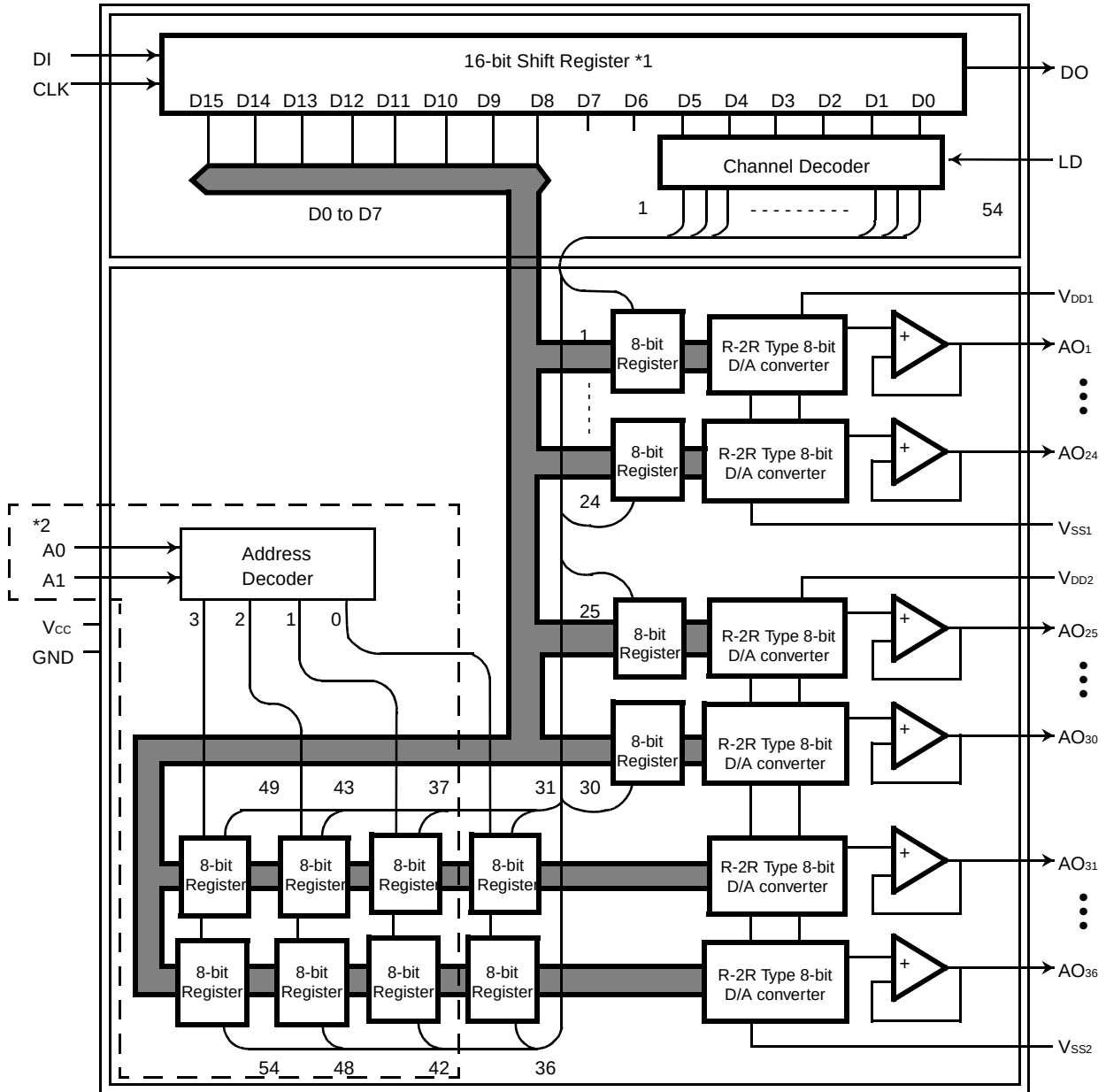
■ PIN DESCRIPTION

Table 1 Pin Description

Pin name	Pin No.					I/O	Description
	MB88344			MB88344B			
	SH-DIP	QFP	LQFP	SH-DIP	LQFP		
DI*	20	13	1	19	1	I	Serial data input pin.
CLK*	21	14	2	20	2	I	Shift clock input pin. Serial data input from DI pin are input to the internal shift register by a rising edge of the CLK signal.
LD*	22	15	3	21	3	I	Load strobe input pin. A “high” level on this pin loads the shift register values into the decoder and 8-bit register.
DO	23	16	4	22	4	O	Serial data output pin. Serial data in the shift register are output from this pin. This pin allows a cascade connection of device.
AO ₁ to AO ₁₁	8 to 18	2 to 12	38 to 48	8 to 18	38 to 48	O	D/A converter outputs #1. The analog supply voltage is referred with V _{DD1} –V _{SS1} . Analog output has an operational amplifier output buffer.
AO ₁₂ to AO ₂₄	27 to 39	21 to 33	9 to 21	27 to 39	9 to 21		
AO ₂₅ to AO ₂₇	40 to 42	34 to 36	22 to 24	40 to 42	22 to 24	O	D/A converter outputs #2. The analog supply voltage is referred with V _{DD2} –V _{SS2} . Analog output has an operational amplifier output buffer.
AO ₂₈ to AO ₃₁	44 to 47	37 to 40	25 to 28	43 to 46	25 to 28		
AO ₃₂ to AO ₃₆	3 to 7	45 to 1	33 to 37	3 to 7	33 to 37		
A0 A1	–	–	–	48 24	30 6	I	Address input pins to select the DAC output register for the AO ₃₁ –AO ₃₆ pins. (Those address inputs are not applied to other analog output pins.)
V _{CC}	48	41	29	47	29	–	Supply voltage pin for digital block and operational amplifier output buffers.
GND	24	17	5	23	5	–	Ground pin for digital block and op-amp. output buffers.
V _{DD1}	26	20	8	26	8	–	Supply voltage pin for D/A converter (for AO ₁ –AO ₂₄ outputs).
V _{SS1}	25	18	7	25	7	–	Ground pin for D/A converter (for AO ₁ –AO ₂₄ outputs).
V _{DD2}	1	42	31	1	31	–	Supply voltage pin for D/A converter (for AO ₂₅ –AO ₃₆ outputs).
V _{SS2}	2	44	32	2	32	–	Ground pin for D/A converter (for AO ₂₅ –AO ₃₆ outputs).
NC	19 43	19 43	6 30	–	–	–	No connection. Those are open pins and do not connect to those pins.

* : DI, CLK, and LD pins should be fixed with “Low” level while no data are transferred.

■ BLOCK DIAGRAM



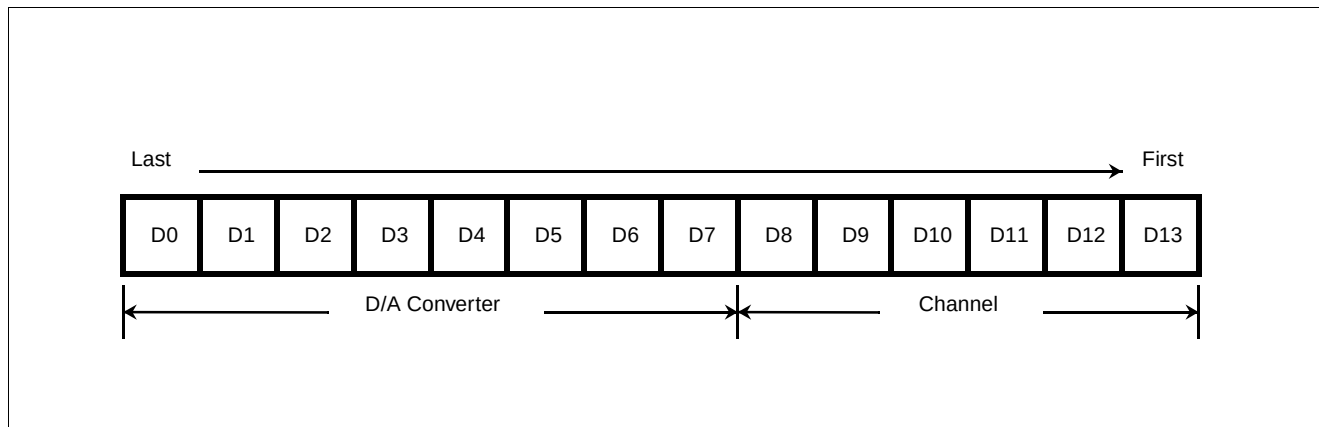
*1 : In MB88344, the Shift register is a 14-bit and the format is MSB-first.

MB88344/MB88344B

■ DEVICE CONTROL

The MB88344 has a 14-bit shift register, and MB88344B has a 16-bit shift register to store the digital data and channel selection.

1. 14-bit Shift Register (MB88344)



D/A Converter Output

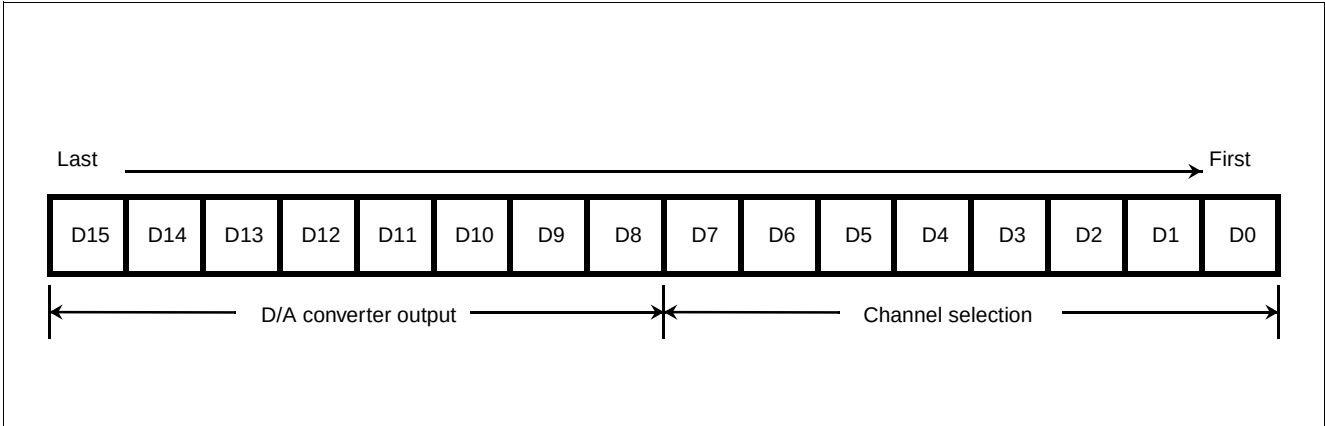
Input data								DAC output
D0	D1	D2	D3	D4	D5	D6	D7	
0	0	0	0	0	0	0	0	$\frac{1}{256} V_{SS}$
1	0	0	0	0	0	0	0	$\frac{1}{256} V_{REF}/256 \times 1 + V_{SS}$
⋮	⋮	⋮	⋮	⋮	⋮	⋮	⋮	⋮
0	1	1	1	1	1	1	1	$\frac{1}{256} V_{REF}/256 \times 254 + V_{SS}$
1	1	1	1	1	1	1	1	$\frac{1}{256} V_{REF}/256 \times 255 + V_{SS}$

$$V_{REF} = V_{DD} - V_{SS}$$

Channel Selection

Input data						Selected channel
D8	D9	D10	D11	D12	D13	
0	0	0	0	0	0	Deselected
0	0	0	0	0	1	AO ₁ to AO ₃₀ selected
0	1	1	1	1	0	
0	1	1	1	1	1	AO ₃₁ to AO ₃₆ selected (address 0)
1	0	0	1	0	0	
1	0	0	1	0	1	Deselected
1	1	1	1	1	1	

2. O16-bit Shift Register (MB88344B)



D/A Converter Output

Input data								DAC output
D15	D14	D13	D12	D11	D10	D9	D8	
0	0	0	0	0	0	0	0	$\frac{V_{REF}}{256} \times 0 + V_{SS}$
0	0	0	0	0	0	0	1	$\frac{V_{REF}}{256} \times 1 + V_{SS}$
$\vdots$	$\vdots$	$\vdots$	$\vdots$	$\vdots$	$\vdots$	$\vdots$	$\vdots$	$\vdots$
1	1	1	1	1	1	1	0	$\frac{V_{REF}}{256} \times 254 + V_{SS}$
1	1	1	1	1	1	1	1	$\frac{V_{REF}}{256} \times 255 + V_{SS}$

$V_{REF} = V_{DD} - V_{SS}$

Channel Selection

Input data								Selected channel
D7	D6	D5	D4	D3	D2	D1	D0	
×	×	0	0	0	0	0	0	Deselected
×	×	0	0	0	0	0	1	AO ₁ to AO ₃₀ selected
×	×	0	1	1	1	1	0	
×	×	0	1	1	1	1	1	AO ₃₁ to AO ₃₆ selected (address 0)
×	×	1	0	0	1	0	0	
×	×	1	0	0	1	0	1	AO ₃₁ to AO ₃₆ selected (address 1)
×	×	1	0	1	0	1	0	
×	×	1	0	1	0	1	1	AO ₃₁ to AO ₃₆ selected (address 2)
×	×	1	1	0	0	0	0	
×	×	1	1	0	0	0	1	AO ₃₁ to AO ₃₆ selected (address 3)
×	×	1	1	0	1	1	0	
×	×	1	1	0	1	1	1	Deselected
×	×	1	1	1	1	1	1	

×: Don't Care

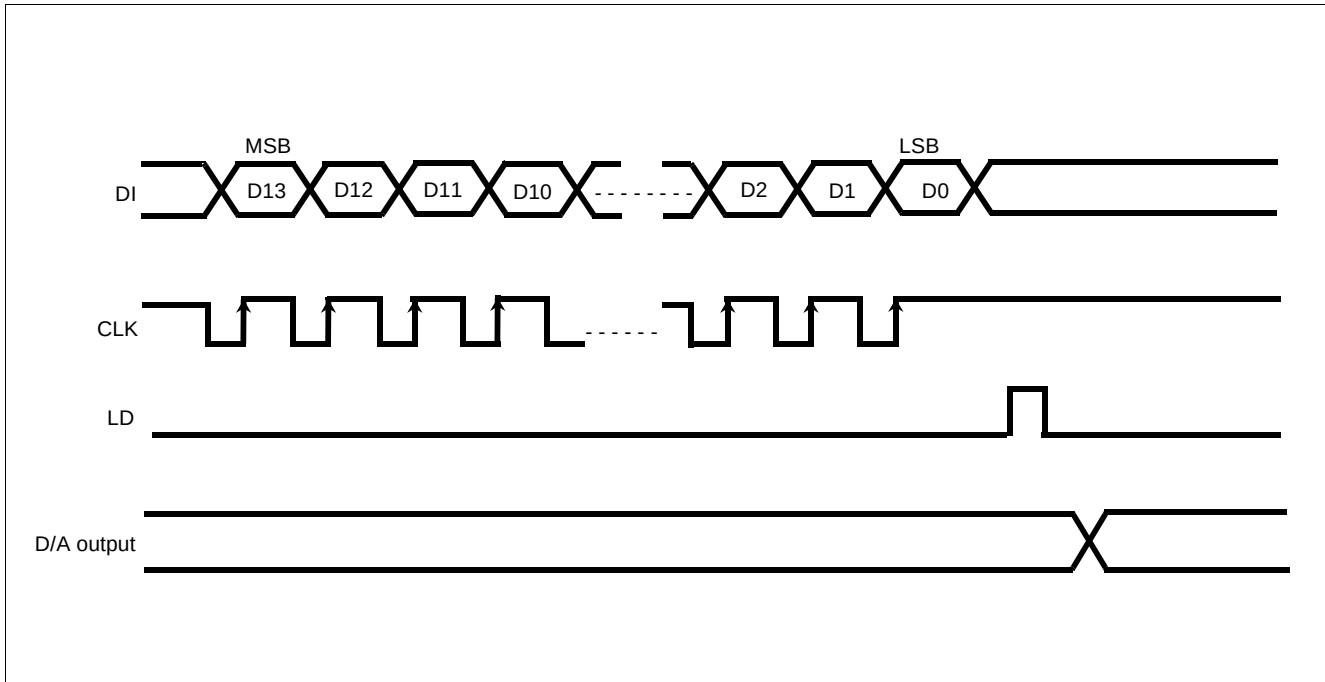
Output Register Selection

A1	A0	Output register selected
0	0	address 0
0	1	address 1
1	0	address 2
1	1	address 3

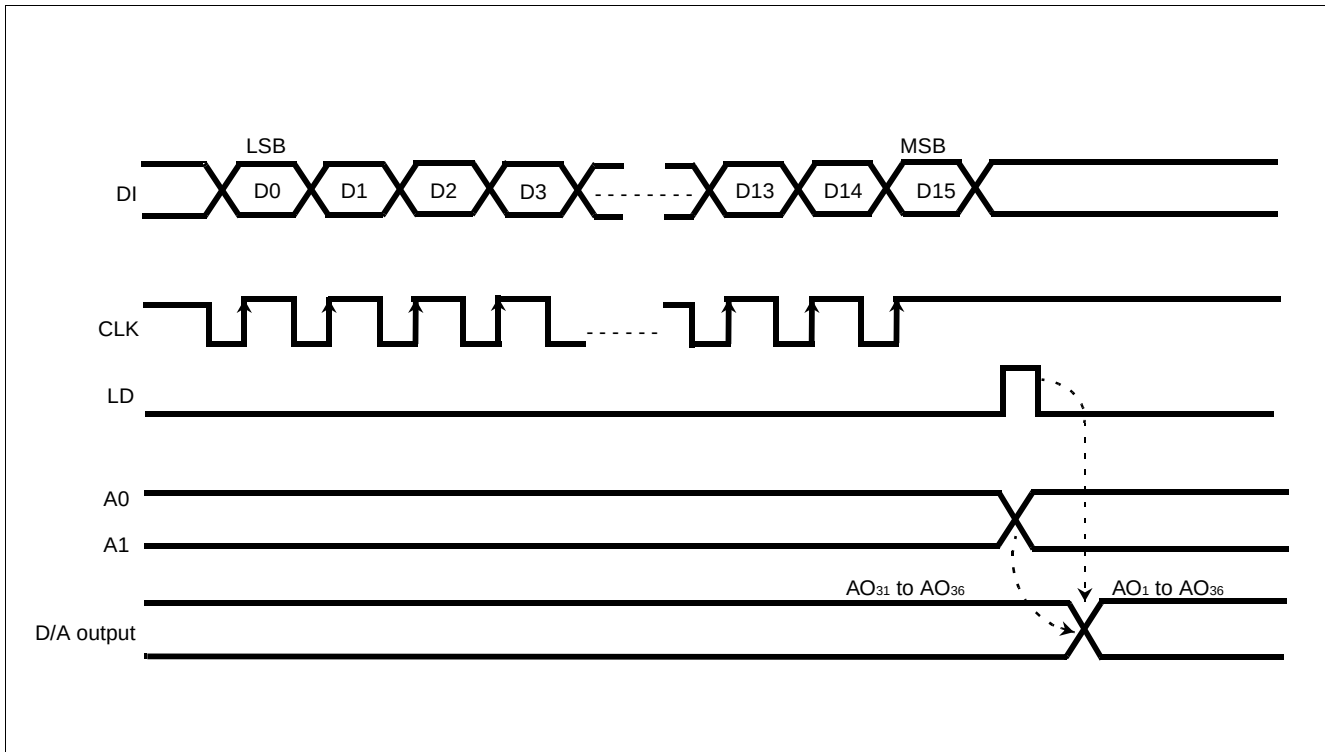
MB88344/MB88344B

■ TIMING CHART

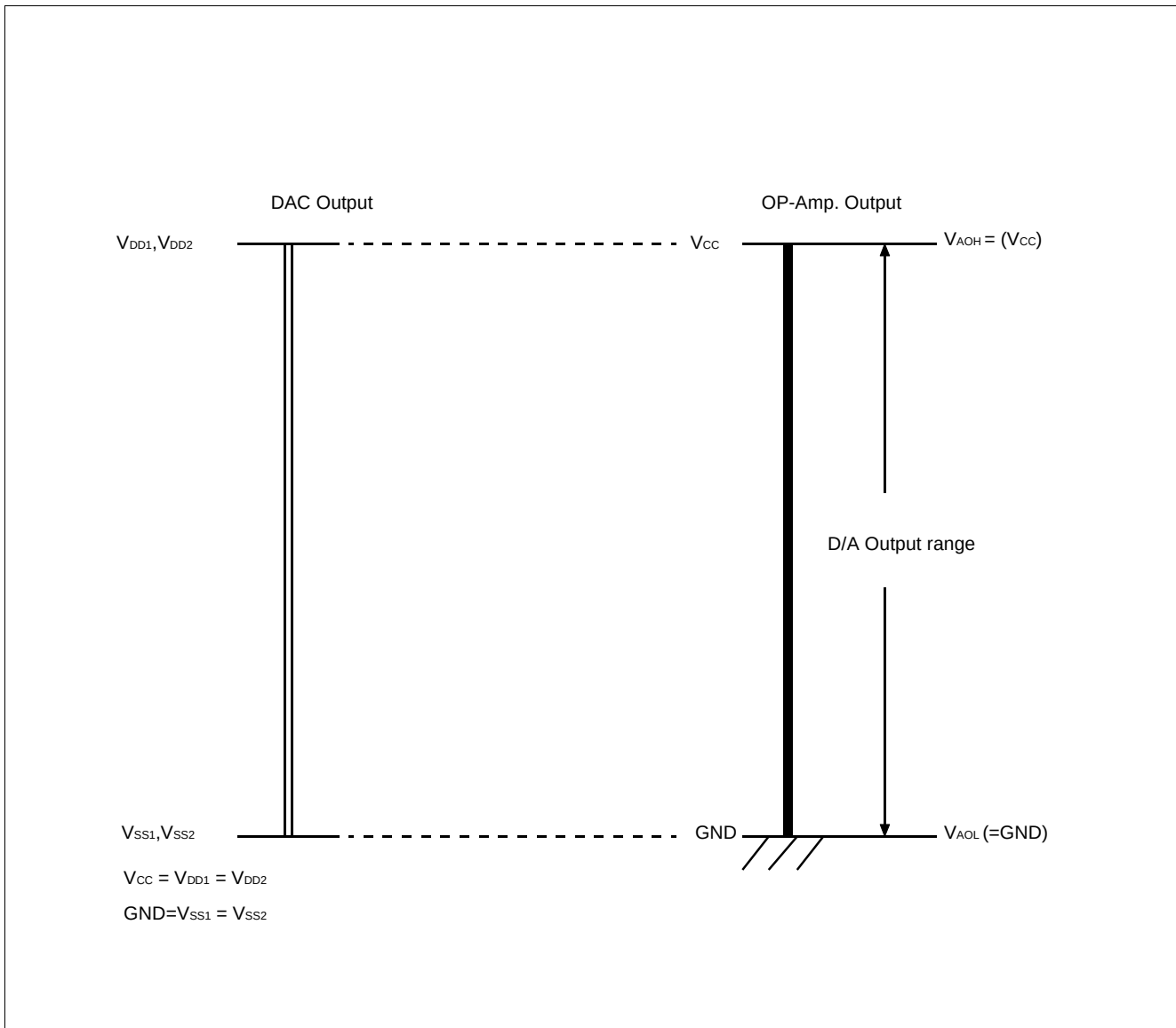
MB88344



MB88344B



■ ANALOG OUTPUT VOLTAGE RANGE



■ ABSOLUTE MAXIMUM RATINGS (See WARNING)

Parameter	Symbol	Condition	Rating			Unit
			Min.	Typ.	Max.	
Power supply voltage	V_{CC}	$T_a = +25^{\circ}\text{C}$ $\text{GND} = 0\text{ V}, V_{DD1} \leq V_{CC},$ $V_{DD2} \leq V_{CC}$	-0.3	—	7.0	V
	V_{DD1}, V_{DD2}		-0.3	—	7.0	V
Input voltage	V_{IN}	$T_a = +25^{\circ}\text{C}$ $\text{GND} = 0\text{ V}$ Should not exceed $V_{CC} + 0.3\text{ V}$	-0.3	—	$V_{CC} + 0.3$	V
Output voltage	V_{OUT}		-0.3	—	$V_{CC} + 0.3$	V
Power dissipation	P_D	—	—	—	250	mW
Operating ambient temperature	T_a	—	-20	—	+85	$^{\circ}\text{C}$
Storage temperature	T_{STG}	—	-55	—	+150	$^{\circ}\text{C}$

WARNING: Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

■ RECOMMENDED OPERATING CONDITIONS

Parameter	Symbol	Condition	Value			Unit
			Min	Typ.	Max.	
Power supply voltage (for MCU interface/ OP-amp. block)	V_{CC}	$V_{CC} \geq V_{DD}$	4.5	5.0	5.5	V
	GND		—	0	—	V
Power supply voltage (for analog block*)	V_{DD1}, V_{DD2}	$V_{DD1} - V_{SS1} \geq 2.0\text{ V},$ $V_{DD2} - V_{SS2} \geq 2.0\text{ V}$	2.0	—	V_{CC}	V
	V_{SS1}, V_{SS2}		GND	—	$V_{CC} - 2.0$	V
Analog output source current	I_{AL}	—	—	—	-1.0	mA
Analog output sink current	I_{AH}	—	—	—	+1.0	mA
Analog output load capacitance for oscillation limit	C_{AL}	—	—	—	1.0	μF
Operating ambient temperature	T_a	—	-20	—	+85	$^{\circ}\text{C}$

* : Except operational amplifier output buffer block. Also, V_{DD1} (V_{SS1}) and V_{DD2} (V_{SS2}) can be set independently.

■ ELECTRICAL CHARACTERISTICS

1. DC Characteristics

(Recommended operating conditions unless otherwise noted.)

Digital Block (MCU Interface)

Parameter	Pin	Symbol	Condition	Value			Unit
				Min.	Typ.	Max.	
Active supply current (V _{CC})*	V _{CC}	I _{CC}	CLK = 1MHz, unloaded	—	3.5	8.0	mA
Input leakage current (CLK, DI, and LD)	CLK DI LD	I _{ILK}	V _{IN} = 0 to V _{CC}	−10	—	+10	μA
Input low voltage (CLK,DI, and LD)		V _{IL}	For MB88344	—	—	0.2•V _{CC}	V
			For MB88344B	—	—	0.6	V
Input high voltage (CLK, DI, and LD)		V _{IH}	For MB88344	0.5•V _{CC}	—	—	V
			For MB88344B	2.1	—	—	V
Output low voltage (DO)	DO	V _{OL}	I _{OL} = 2.5 mA	—	—	0.4	V
Output high voltage (DO)		V _{OH}	I _{OH} = −400 μA	V _{CC} − 0.4	—	—	V

* : Including the supply current to the operational amplifier block

Analog Block (D/A Converters with Operational Amplifier Output Buffers)

Parameter	Symbol	Pin	Condition	Value			Unit
				Min.	Typ.	Max.	
Supply current (V_{DD})**	I_{DD}	V_{DD1} V_{DD2}	Unloaded, I_{DD} is a total current value for DAC outputs #1 and #2.	—	4.5	6.5	mA
Min. analog output voltage 1 (AO _x)	V_{AOL1}	AO ₁ to AO ₃₆	$V_{DD1,2} = V_{CC}$ $V_{SS1,2} = GND = 0.0V$ $I_{AL} = 0 \mu A$ Digital data = #00	$V_{SS1,2}$	—	$V_{SS1,2} + 0.1$	V
Min. analog output voltage 2 (AO _x)	V_{AOL2}		$V_{DD1,2} = V_{CC} = 5.0 V$ $V_{SS1,2} = GND = 0.0 V$ $I_{AL} = 500 \mu A$ Digital data = #00	$V_{SS1,2} - 0.2$	$V_{SS1,2}$	$V_{SS1,2} + 0.2$	V
Min. analog output voltage 3 (AO _x)	V_{AOL3}		$V_{DD1,2} = V_{CC} = 5.0 V$ $V_{SS1,2} = GND = 0.0 V$ $I_{AH} = 500 \mu A$ Digital data = #00	$V_{SS1,2}$	—	$V_{SS1,2} + 0.2$	V
Min. analog output voltage 4 (AO _x)	V_{AOL4}		$V_{DD1,2} = V_{CC} = 5.0 V$ $V_{SS1,2} = GND = 0.0 V$ $I_{AL} = 1.0 mA$ Digital data = #00	$V_{SS1,2} - 0.3$	$V_{SS1,2}$	$V_{SS1,2} + 0.3$	V
Min. analog output voltage 5 (AO _x)	V_{AOL5}		$V_{DD1,2} = V_{CC} = 5.0 V$ $V_{SS1,2} = GND = 0.0 V$ $I_{AH} = 1.0 mA$ Digital data = #00	$V_{SS1,2}$	—	$V_{SS1,2} + 0.3$	V
Max. analog output voltage 1 (AO _x)	V_{AOH1}		$V_{DD1,2} = V_{CC}$ $V_{SS1,2} = GND = 0.0 V$ $I_{AL} = 0 \mu A$ Digital data = #FF	$V_{DD1,2} - 0.1$	—	$V_{DD1,2}$	V
Max. analog output voltage 2 (AO _x)	V_{AOH2}		$V_{DD1,2} = V_{CC} = 5.0 V$ $V_{SS1,2} = GND = 0.0 V$ $I_{AL} = 500 \mu A$ Digital data = #FF	$V_{DD1,2} - 0.2$	—	$V_{DD1,2}$	V
Max. analog output voltage 3 (AO _x)	V_{AOH3}		$V_{DD1,2} = V_{CC} = 5.0 V$ $V_{SS1,2} = GND = 0.0 V$ $I_{AH} = 500 \mu A$ Digital data = #FF	$V_{DD1,2} - 0.2$	$V_{DD1,2}$	$V_{DD1,2} + 0.2$	V
Max. analog output voltage 4 (AO _x)	V_{AOH4}		$V_{DD1,2} = V_{CC} = 5.0 V$ $V_{SS1,2} = GND = 0.0 V$ $I_{AL} = 1.0 mA$ Digital data = #FF	$V_{DD1,2} - 0.3$	—	$V_{DD1,2}$	V
Max. analog output voltage 5 (AO _x)	V_{AOH5}		$V_{DD1,2} = V_{CC} = 5.0 V$ $V_{SS1,2} = GND = 0.0 V$ $I_{AH} = 1.0 mA$ Digital data = #FF	$V_{DD1,2} - 0.3$	$V_{DD1,2}$	$V_{SS1,2} + 0.3$	V
Resolution (AO _x)	Res			—	8	—	bit
Linearity error (AO _x)	LE		Unloaded, $V_{DD} \leq V_{CC} - 0.1 V$, $V_{SS} \geq 0.1V$	-1.5	—	1.5	LSB
Differential linearity error (AO _x)	DLE		Unloaded	-1.0	—	1.0	LSB

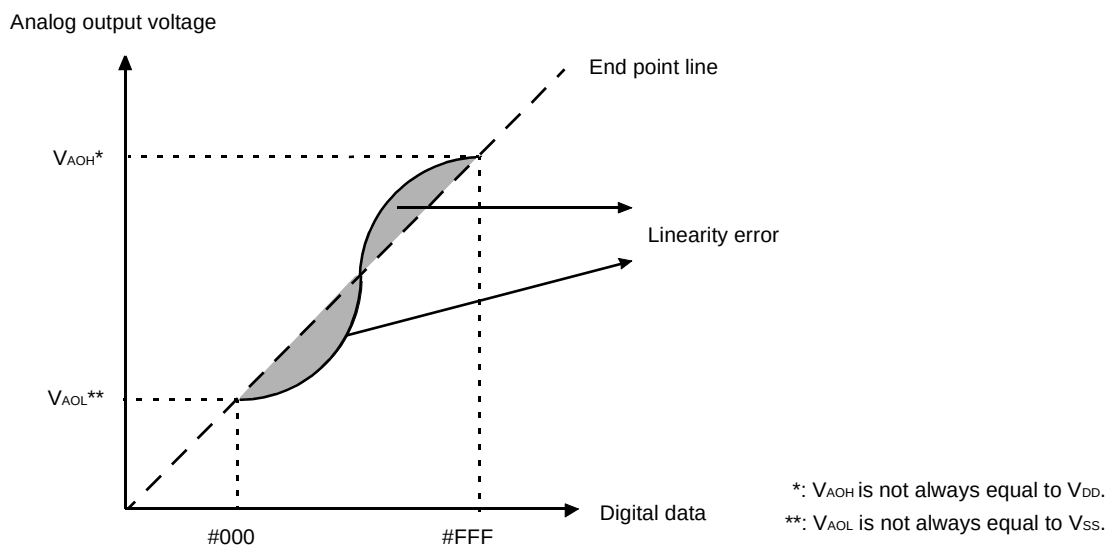
** : Excluding the supply current to the operational amplifier block

2. AC Characteristics

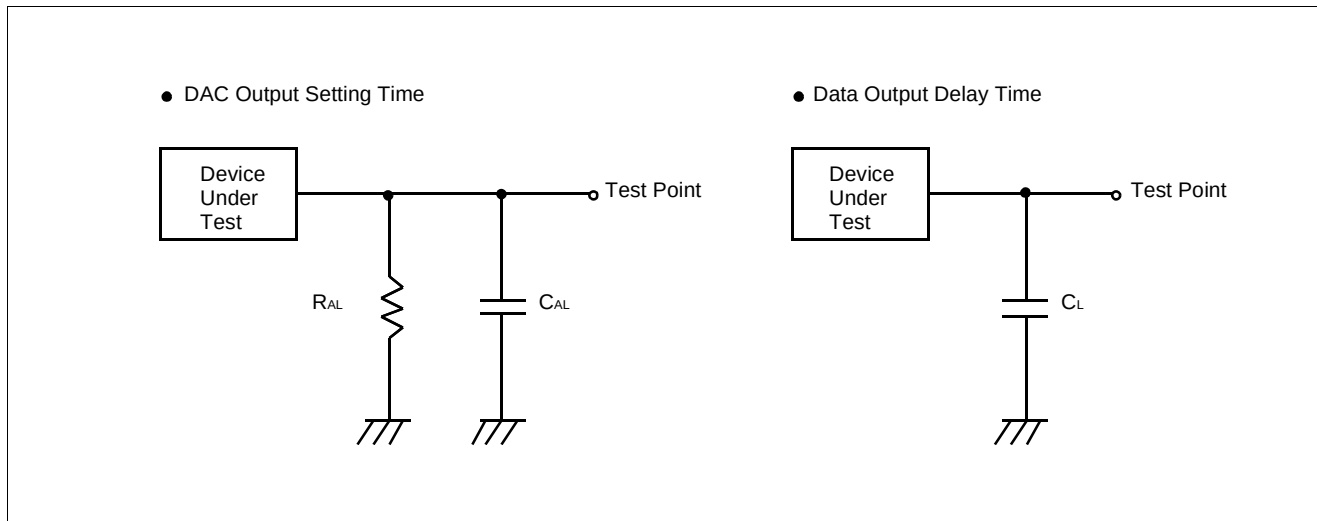
(Recommended operating conditions unless otherwise noted.)

Parameter	Symbol	Condition	Value		Unit
			Min.	Max.	
Clock low time	t_{CKL}	—	200	—	ns
Clock high time	t_{CKH}	—	200	—	ns
Clock rise time	t_{Cr}	—	—	200	ns
Clock fall time	t_{Cf}	—	—	200	ns
Data setup time	t_{DCH}	—	30	—	ns
Data hold time	t_{CHD}	—	60	—	ns
Load strobe high time	t_{LDH}	—	100	—	ns
Load strobe setup time	t_{CHL}	—	200	—	ns
Load strobe hold time	t_{LDC}	—	100	—	ns
DAC output setting time	t_{LDD}	* $R_{AL} = 10\text{ k}\Omega$, $C_{AL} = 50\text{ pF}$	—	100	μs
Data output delay time	t_{DO}	** $C_L = 20\text{ pF}$ (Min.), 100 pF (Max.)	70	350	ns

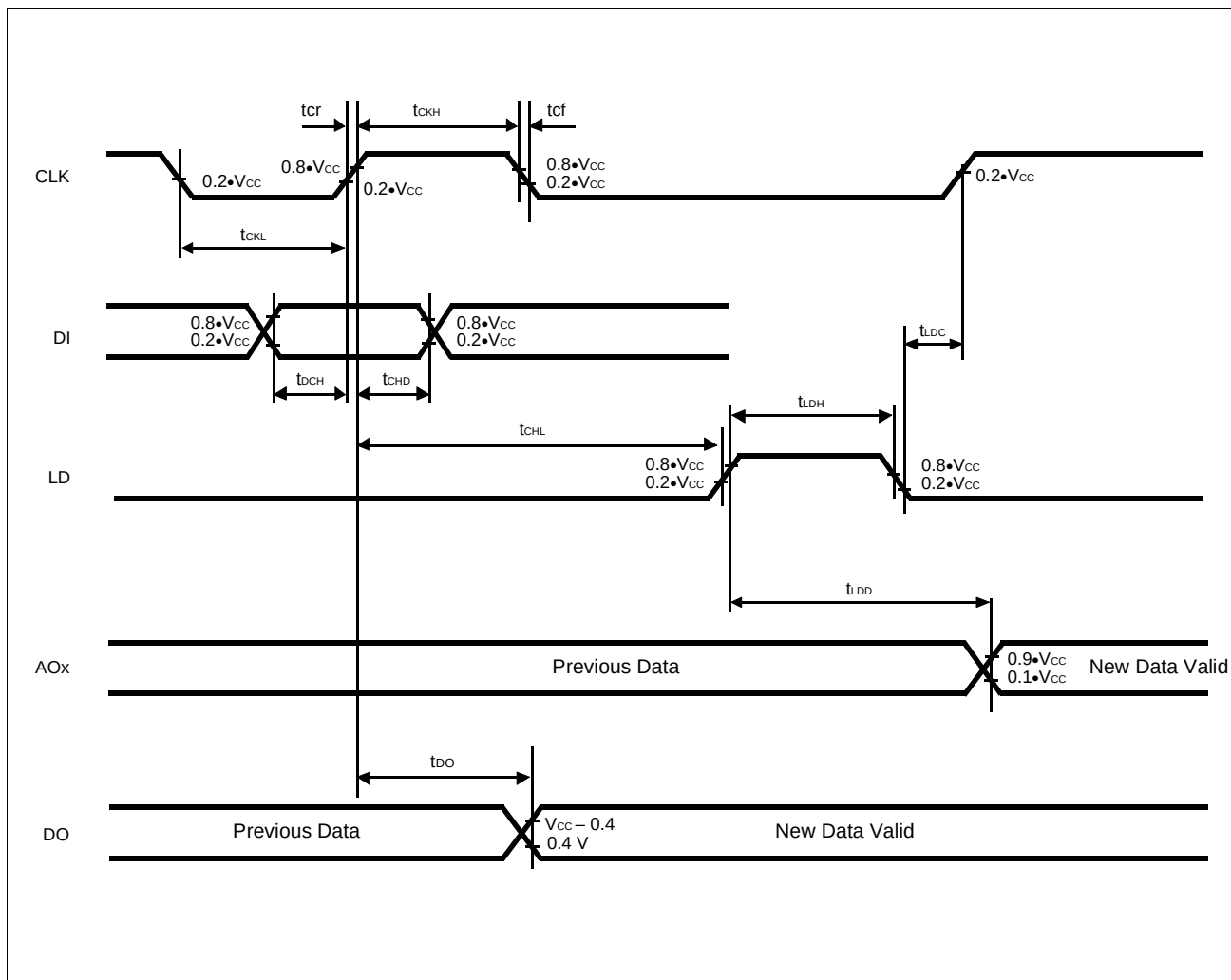
■ DEFINITION OF NONLINEARITY ERROR



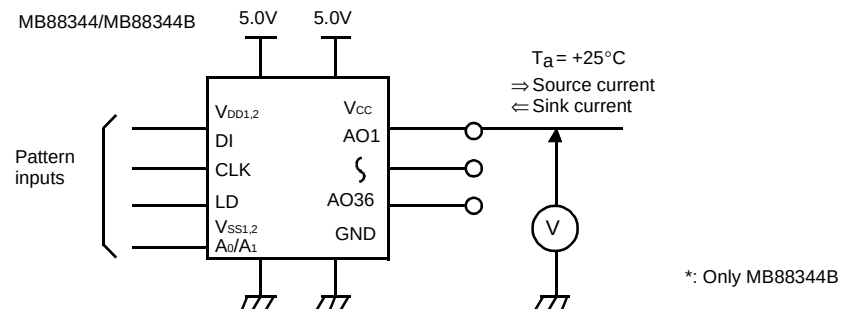
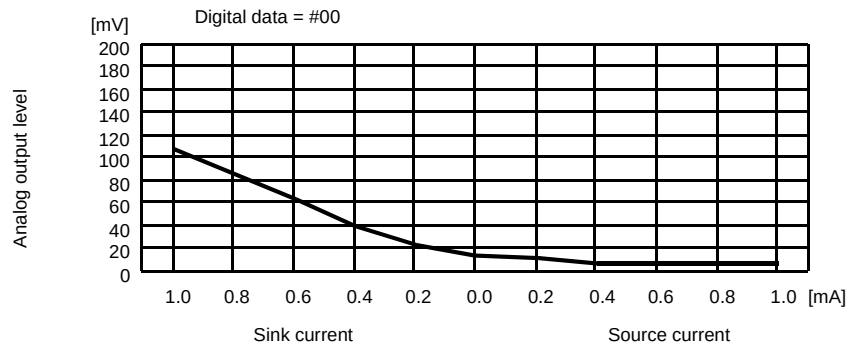
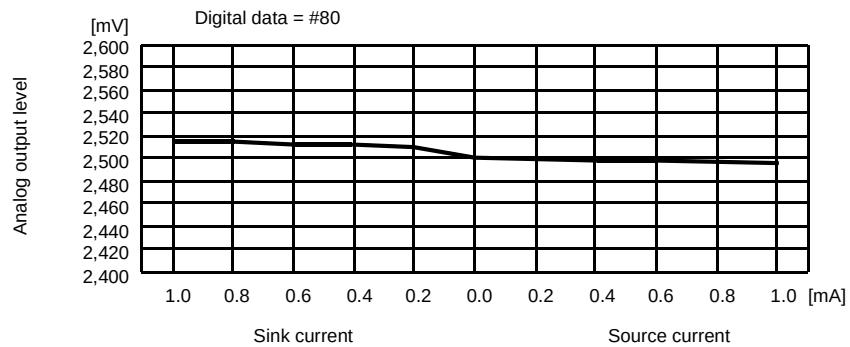
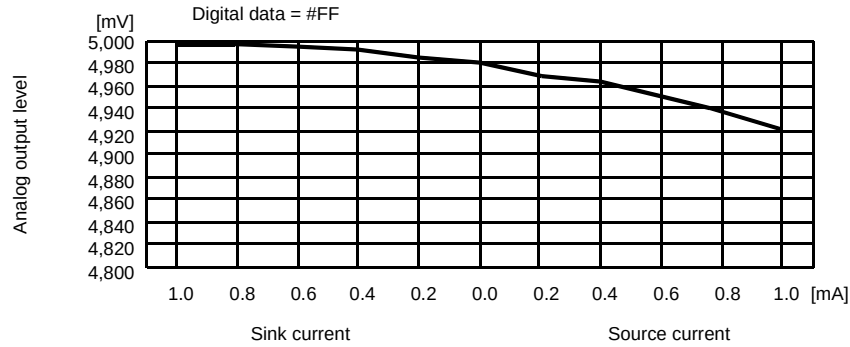
■ AC TEST CONDITIONS



■ INPUT/OUTPUT TIMING



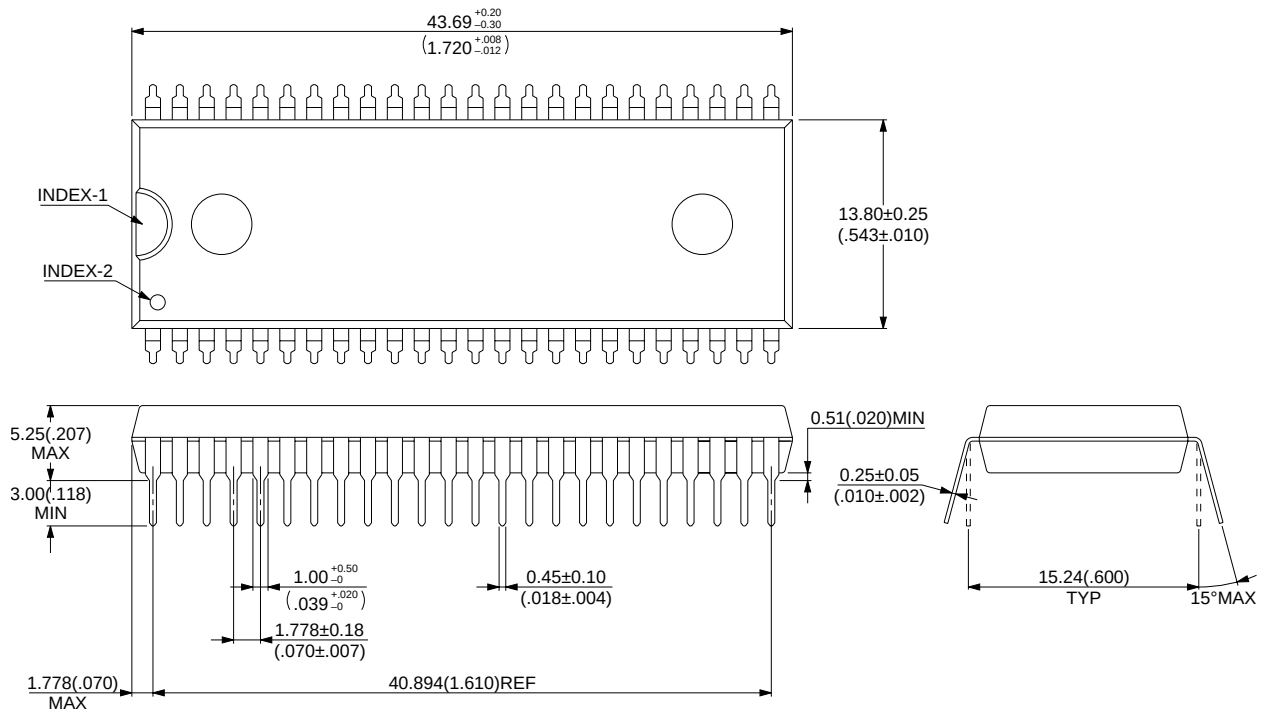
■ V_{AO} vs. I_{AO} CHARACTERISTIC CURVE (EXAMPLE)



MB88344/MB88344B

■ PACKAGE DIMENSIONS

48-pin Plastic SH-DIP
(DIP-48P-M01)



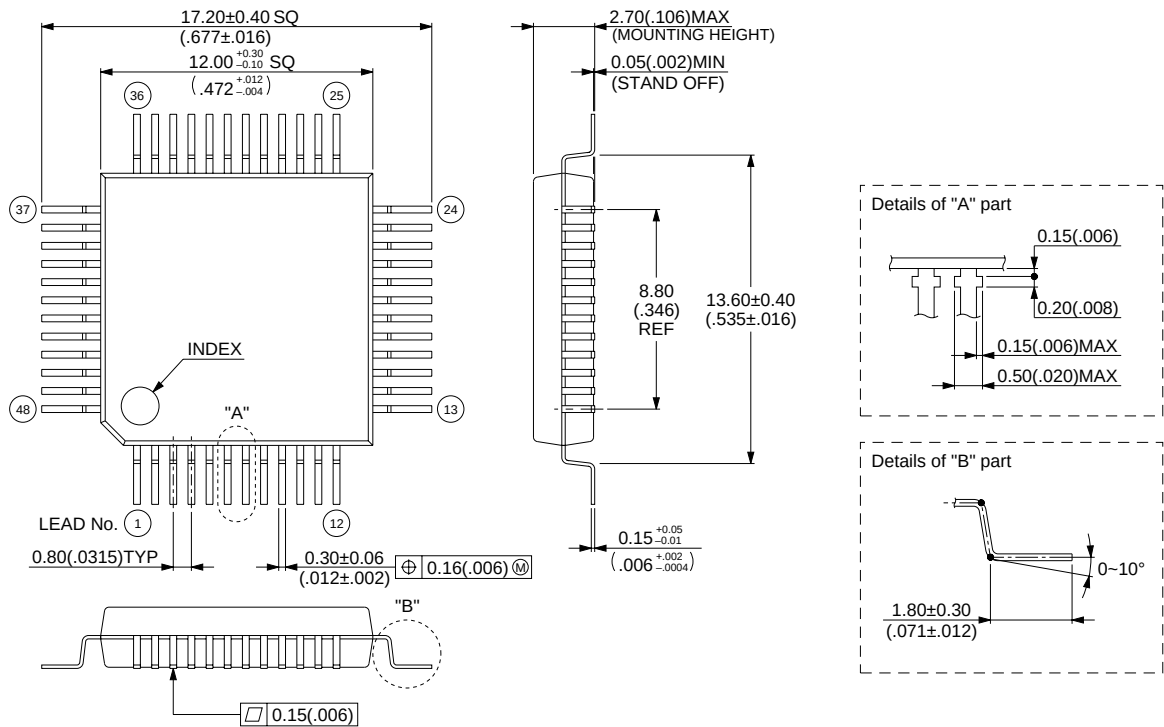
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Dimensions in mm (inches)

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48-pin Plastic QFP
(FPT-48P-M16)



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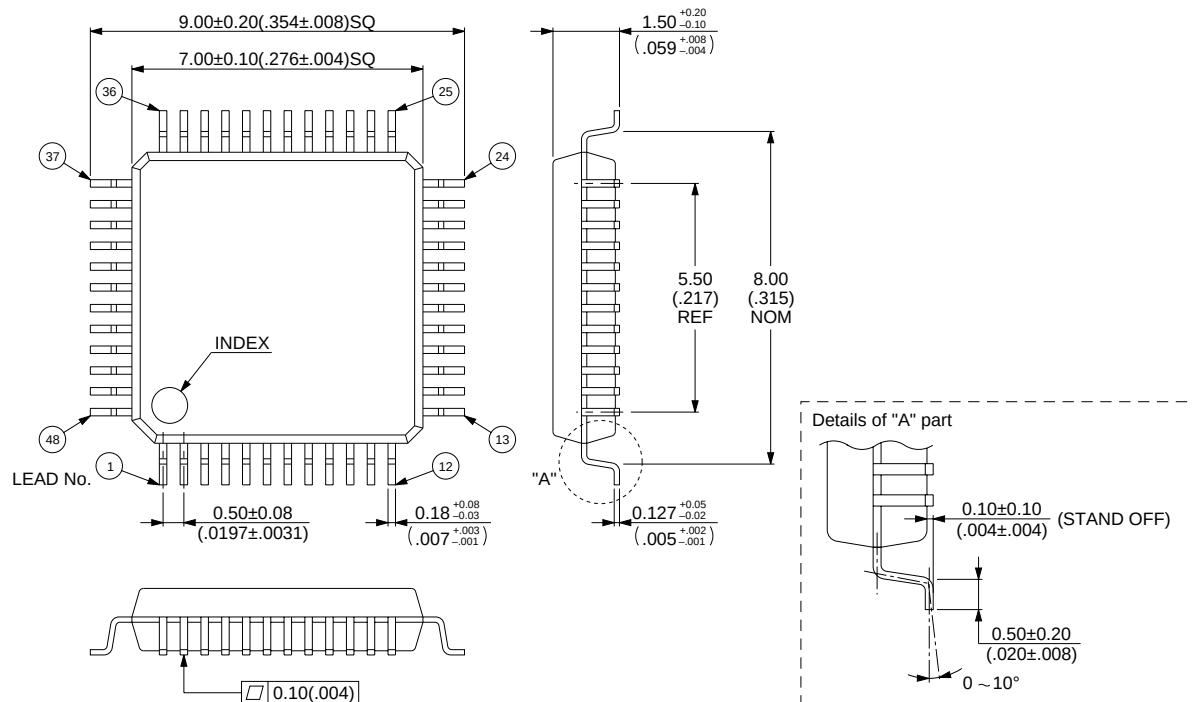
Dimensions in mm (inches)

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MB88344/MB88344B

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48-pin Plastic LQFP
(FPT-48P-M05)



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Dimensions in mm (inches)

FUJITSU LIMITED

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